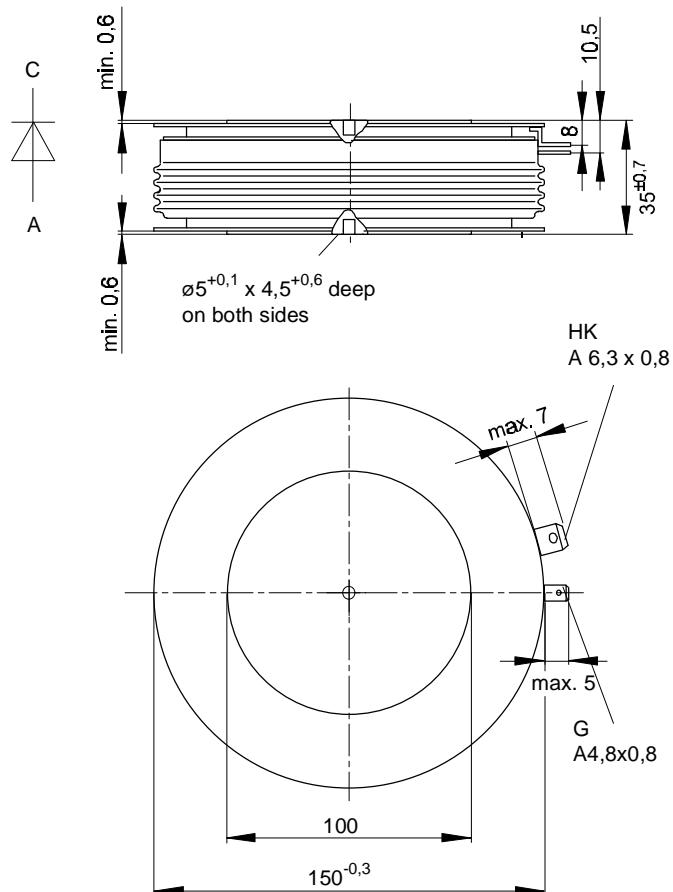




European Power-
Semiconductor and
Electronics Company

Marketing Information T 2451 N



T 2451 N

Elektrische Eigenschaften Electrical properties

Höchstzulässige Werte Maximum rated values

Periodische Vorwärts- und Rückwärts-Spitzenperrspannung	repetitive peak forward off-state and reverse voltages	$t_{vj} = -40^\circ\text{C} \dots t_{vj \max}$	V_{DRM}, V_{RRM}	3600 3800	V
Vorwärts-Stoßspitzenperrspannung	non-repetitive peak forward off-state voltage	$t_{vj} = -40^\circ\text{C} \dots t_{vj \max}$	$V_{DSM} = V_{DRM}$	3600 3800	V
Rückwärts-Stoßspitzenperrspannung	non-repetitive peak reverse voltage	$t_{vj} = +25^\circ\text{C} \dots t_{vj \max}$	$V_{RSM} = V_{RRM}$	4000 4200 3700 3900	V
Durchlaßstrom-Grenzeffektivwert	RMS on-state current			4100 4300	
Dauergrenzstrom	average on-state current	$t_c = 85^\circ\text{C}$ $t_c = 62^\circ\text{C}$	I_{TRMSM} I_{TAVM}	5300 2450 3400	A
Stoßstrom-Grenzwert	surge current	$t_{vj} = 25^\circ\text{C}, t_p = 10 \text{ ms}$ $t_{vj} = t_{vj \max}, t_p = 10 \text{ ms}$	I_{TSM}	65000 ¹⁾ 57000 ¹⁾	A
Grenzlastintegral	$I^2 t$ -value	$t_{vj} = 25^\circ\text{C}, t_p = 10 \text{ ms}$ $t_{vj} = t_{vj \max}, t_p = 10 \text{ ms}$	$I^2 t$	$21 \cdot 10^6$ $16 \cdot 10^6$	$\text{A}^2 \text{s}$ $\text{A}^2 \text{s}$
Kritische Stromsteilheit	critical rate of rise of on-state current	$v_D \leq 67\%, V_{DRM}, f = 50 \text{ Hz}$	$(di_T/dt)_{cr}$	50	$\text{A}/\mu\text{s}$
Kritische Spannungssteilheit	$i_{GM} = 1,5 \text{ A}, di_G/dt = 1,5 \text{ A}/\mu\text{s}$	$t_{vj} = t_{vj \max}, V_D = 67\% V_{DRM}$	$(dv/dt)_{cr}$	1000	$\text{V}/\mu\text{s}$

Charakteristische Werte Characteristic values

Durchlaßspannung	on-state voltage	$t_{vj} = t_{vj \max}, i_T = 10 \text{ kA}$	V_T	max. 3,05	V
Schleusenspannung	threshold voltage	$t_{vj} = t_{vj \max}$	$V_{T(TO)}$	1,17	V
Ersatzwiderstand	slope resistance	$t_{vj} = t_{vj \max}$	r_T	0,176	$\text{m}\Omega$
Zündstrom	gate trigger current	$t_{vj} = 25^\circ\text{C}, V_D = 6 \text{ V}$	I_{GT}	max. 300	mA
Zündspannung	gate trigger voltage	$t_{vj} = 25^\circ\text{C}, V_D = 6 \text{ V}$	V_{GT}	max. 2,5	V
Nicht zündender Steuerstrom	gate non-trigger current	$t_{vj} = t_{vj \max}, V_D = 6 \text{ V}$	I_{GD}	max. 20	mA
Nicht zündende Steuerspannung	gate non-trigger voltage	$t_{vj} = t_{vj \max}, V_D = 0,5 V_{DRM}$	V_{GD}	max. 10	mA
Haltestrom	holding current	$t_{vj} = 25^\circ\text{C}, V_D = 12 \text{ V}, R_A = 4,7 \Omega$	I_H	max. 350	mA
Einraststrom	latching current	$t_{vj} = 25^\circ\text{C}, V_D = 12 \text{ V}, R_{GK} \geq 10 \Omega$	I_L	max. 2000	mA
Vorwärts- und Rückwärts-Sperrstrom	forward off-state and reverse currents	$i_{GM} = 1 \text{ A}, di_G/dt = 1 \text{ A}/\mu\text{s}, t_g = 20 \mu\text{s}$	i_D, i_R	max. 430	mA
Zündverzug	gate controlled delay time	$t_{vj} = 25^\circ\text{C}, i_{GM} = 1 \text{ A}, di_G/dt = 1 \text{ A}/\mu\text{s}$	t_{gd}	max. 2,3	μs
Freiwerdezeit	circuit commutated turn-off time	siehe Techn.Erl./see Techn. Inf.	t_q	typ. 370	μs

Thermische Eigenschaften Thermal properties

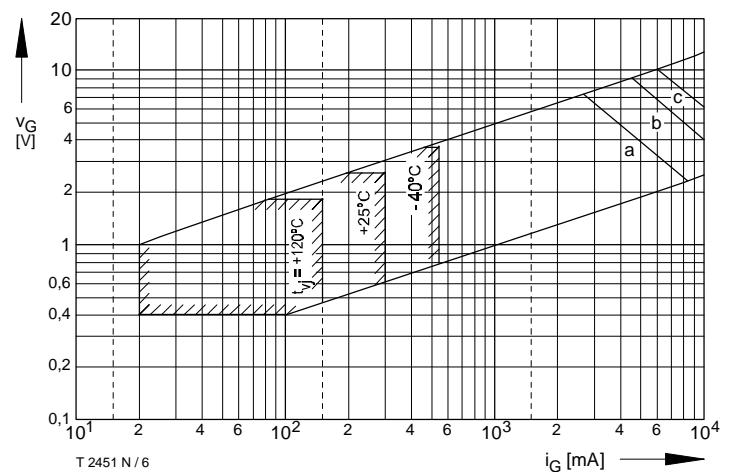
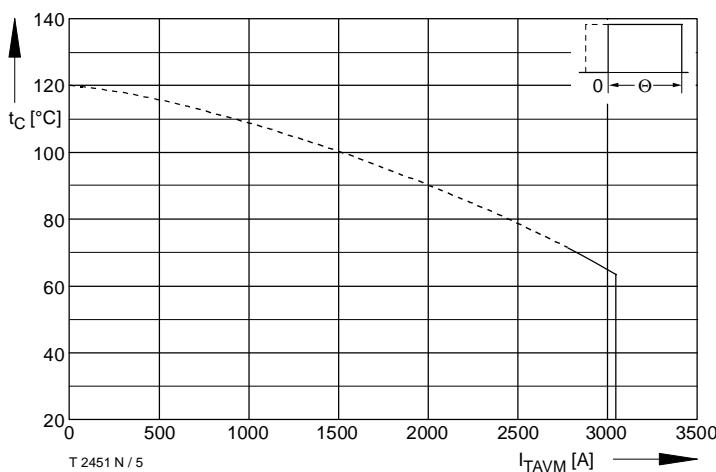
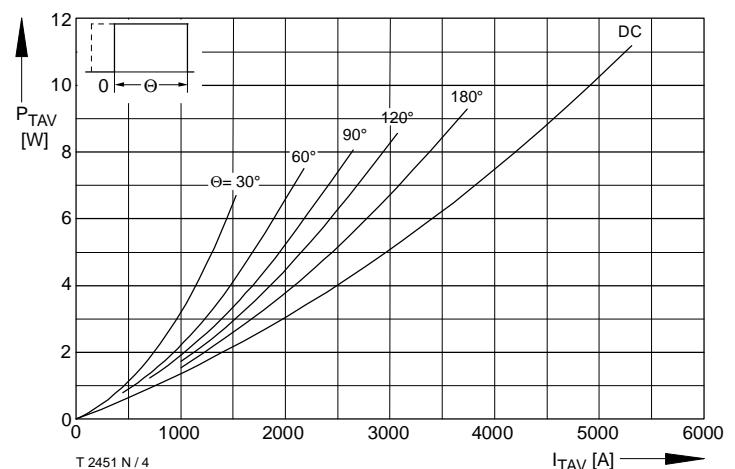
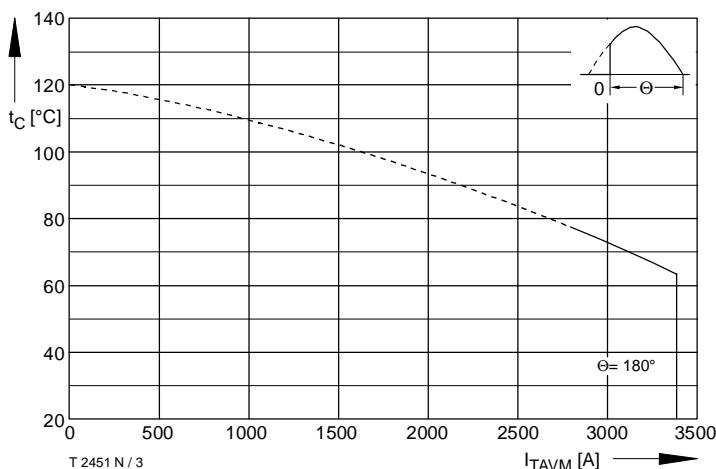
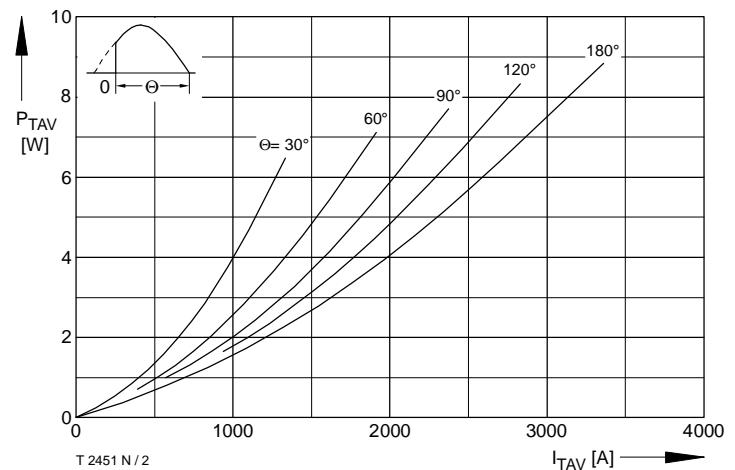
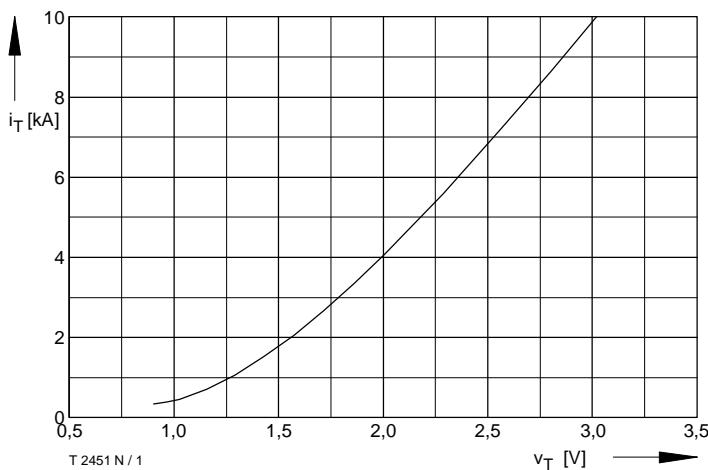
Innerer Wärmewiderstand für beidseitige Kühlung	thermal resistance, junction to case for two-sided cooling	$\Theta = 180^\circ \text{ el, sin}$	R_{thJC}	max. 0,0064	$^\circ\text{C}/\text{W}$
Übergangs-Wärmewiderstand	thermal resistance, case to heatsink	DC beidseitig/two-sided	R_{thCK}	max. 0,0060 max. 0,0015	$^\circ\text{C}/\text{W}$
Höchstzul.Sperrschnitttemperatur	max. junction temperature			$t_{vj \max}$	120 $^\circ\text{C}$
Betriebstemperatur	operating temperature			$t_{c op}$	-40...+120 $^\circ\text{C}$
Lagertemperatur	storage temperature			t_{stg}	-40...+150 $^\circ\text{C}$

Mechanische Eigenschaften Mechanical properties

Si-Elemente mit Druckkontakt	Si-pellet with pressure contact				
Anpreßkraft	clamping force		F	63...91	kN
Gewicht	weight		G	typ. 3000	g
Kriechstrecke	creepage distance			33	mm
Feuchtekategorie	humidity classification	DIN 40040			C
Schwingfestigkeit	vibration resistance	$f = 50 \text{ Hz}$		50	m/s^2
Maßbild, anliegend	outline, attached				

¹⁾ Gehäusegrenzstrom 40 kA (Sinushalbwelle 50 Hz)/Current limit of case 40 kA (sinusoidal half-wave 50 Hz)

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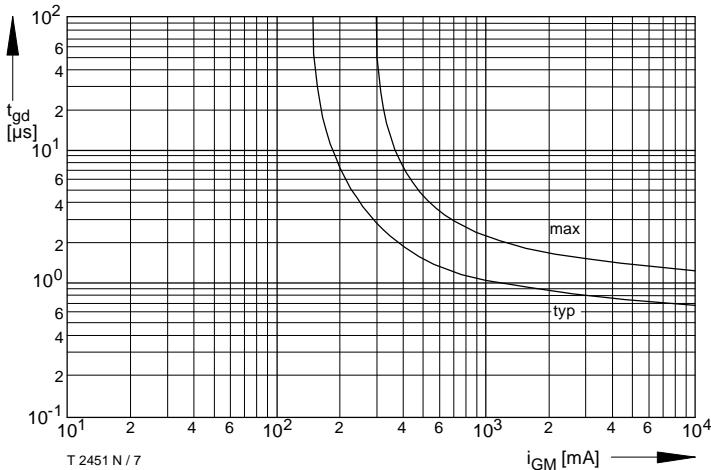


Bild / Fig. 7

Zündverzug / Gate controlled delay time $t_{gd} = f(i_{GM})$

$t_{vj} = 25^\circ\text{C}, \frac{di_G}{dt} = i_{GM}/1\mu\text{s}$

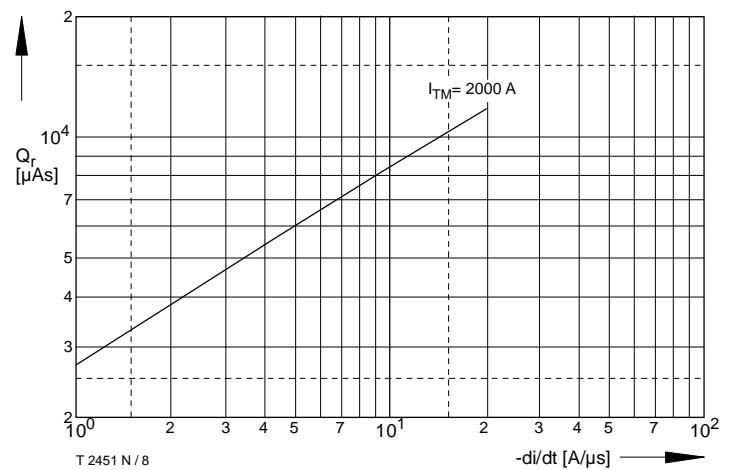


Bild / Fig. 8

Sperrverzögerungsladung / Recovered charge $Q_r = f(-di/dt)$

$t_{vj} = t_{vj} \text{ max}, V_R = 0,5 V_{RRM}, V_{RM} = 0,8 V_{RRM}$

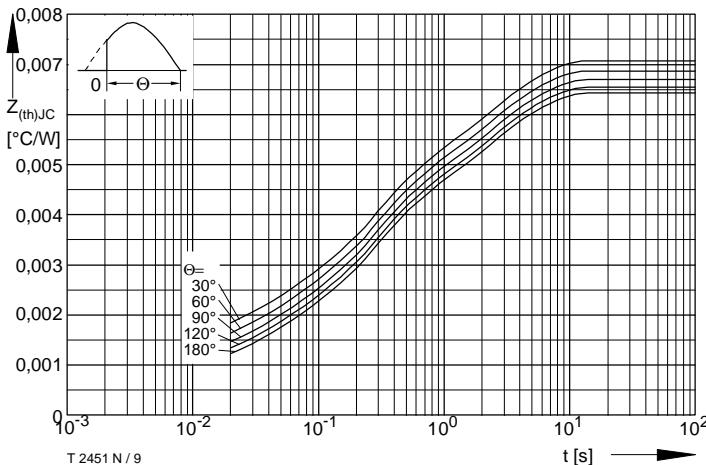
Parameter: Durchlaßstrom / On-state current i_{TM} 

Bild / Fig. 9

Transienter innerer Wärmewiderstand / Transient thermal impedance

$Z_{thJC} = f(t)$

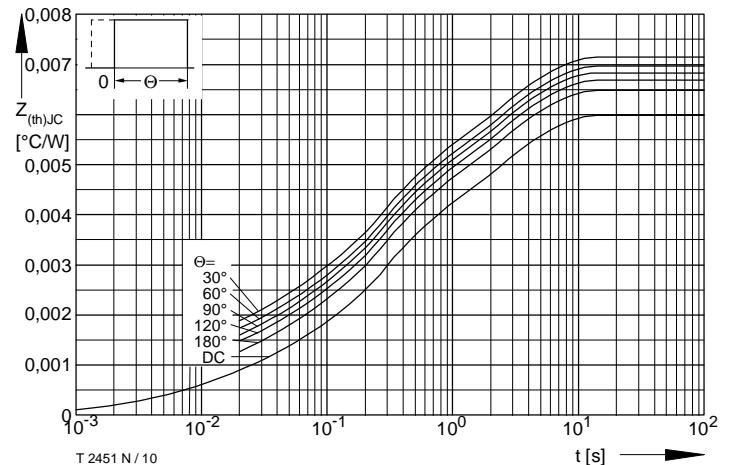
Parameter: Stromflußwinkel / current conduction angle θ 

Bild / Fig. 10

Transienter innerer Wärmewiderstand / Transient thermal impedance

$Z_{thJC} = f(t)$

Parameter: Stromflußwinkel / current conduction angle θ Analytische Elemente des transienten Wärmewiderstandes Z_{thJC} pro Zweig für DC
Analytical elements of transient thermal impedance Z_{thJC} per arm for DC

Pos. n	1	2	3	4	5
$R_{thn} [\text{°C/W}]$	0,0003844	0,00074	0,00185	0,0038	0,00327
$\tau_n [\text{s}]$	0,0012	0,007	0,056	0,27	3,08

Analytische Funktion / Analytical function:

$$Z_{thJC} = \sum_{n=1}^{n_{\max}} R_{thn} (1 - e^{-\frac{t}{\tau_n}})$$